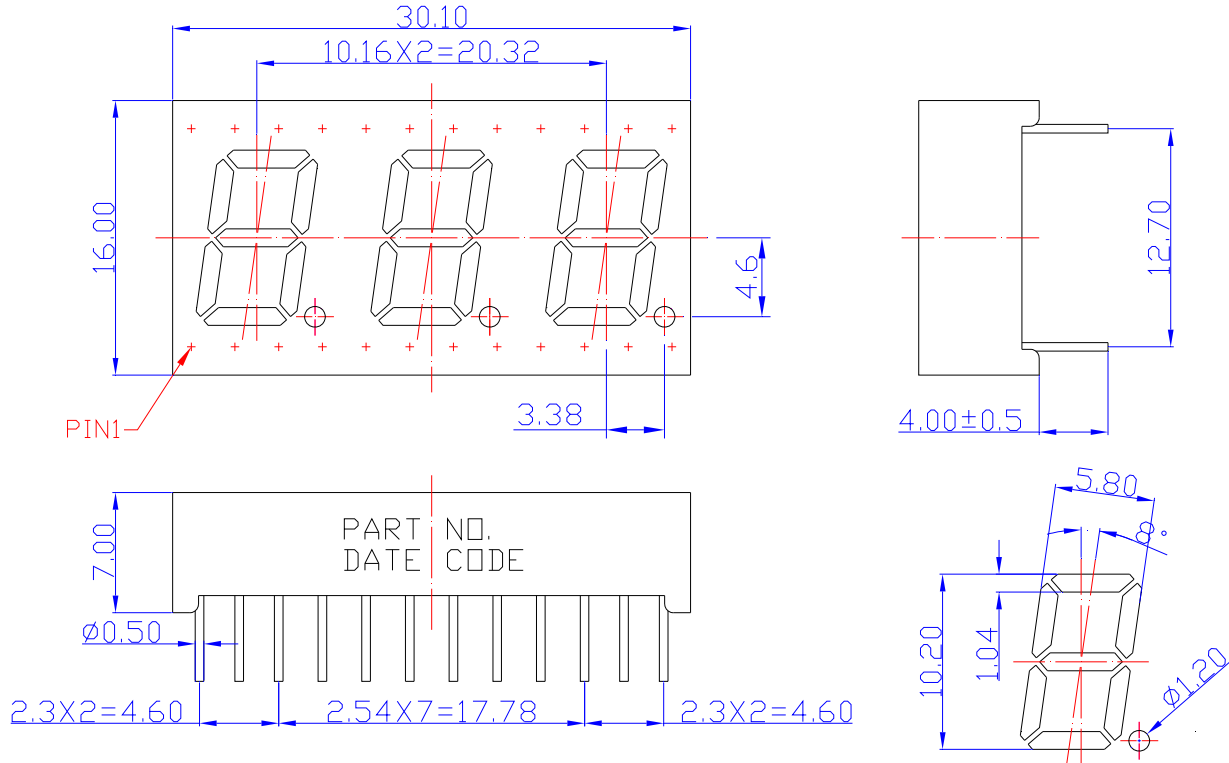


SPECIFICATIONS
CDTA40B2WF
OUTLINES DIMENSIONS

Notes:

1. All Dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Description
CDTA40B2WF	InGaN	Blue	White Segment	Common Anode



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ABSOLUTE MAXIMUM RATINGS
(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Power Dissipation	PD	120	mW
Pulse Forward Current	IFP	100	mA
Continuous Forward Current	IF	30	mA
Reverse Voltage Segment	VR	5	V
Operating Temperature Range	TOPR	-25~+85	°C
Storage Temperature Range	TSTG	-25~+85	°C
IFP = Pulse Width ≤ 10 ms, Duty Ratio ≤ 1/10. Soldering Condition: 260 °C/ 5sec			

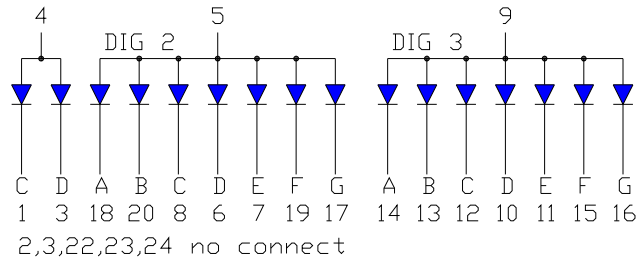
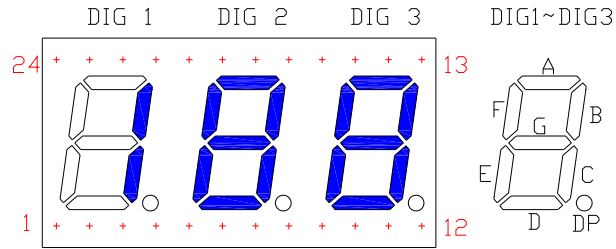
OPTICAL-ELECTRICAL CHARACTERISTICS
(TA=25°C)

Parameter	Symbol	Test Condition	Value			Unit
			Min	Typ	Max	
Luminous Intensity	IV	IF = 20mA	-	40	-	mcd
Forward Voltage	VF	IF = 20mA	-	3.0	4.0	V
Reverse Leakage Current	IR	VR = 5V	-	-	10	µA
Dominant Wavelength	λD	IF = 20mA	460	465	475	nm
Spectral Radiation Bandwidth	Δλ	IF = 20mA	-	40	-	nm



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TYPICAL INTERNAL EQUIVALENT CIRCUIT



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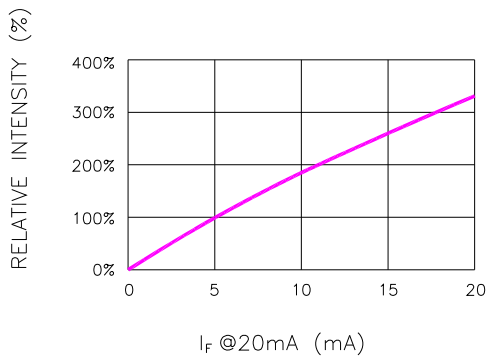
OPTICAL CHARACTERISTIC CURVES
**Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)**


Fig.1 RELATIVE INTENSITY VS. FORWARD CURRENT

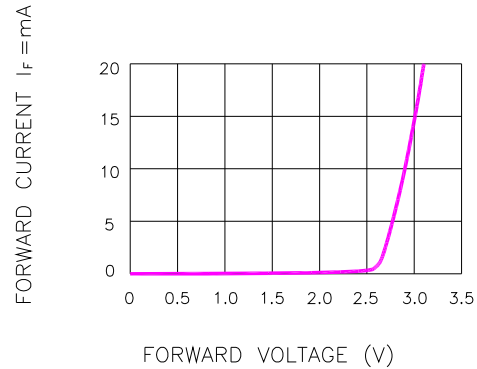


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

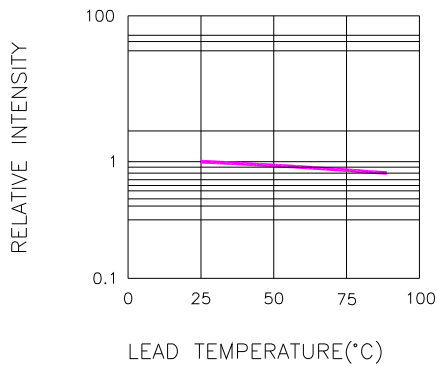
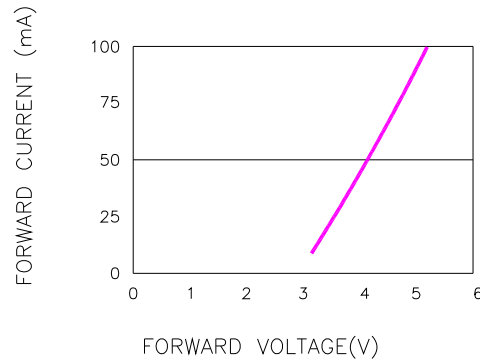

 Fig.3 RELATIVE INTENSITY VS. LEAD TEMPERATURE
(PULSED 20 mA; 300us PULSE, 10ms PERIOD)


Fig.4 PEAK FORWARD VOLTAGE VS. FORWARD (100us TEST PULSE, 1% DUTY CYCLE)

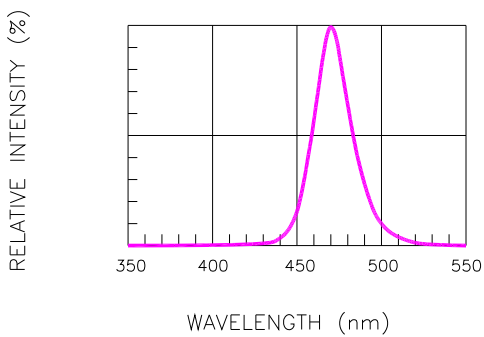


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

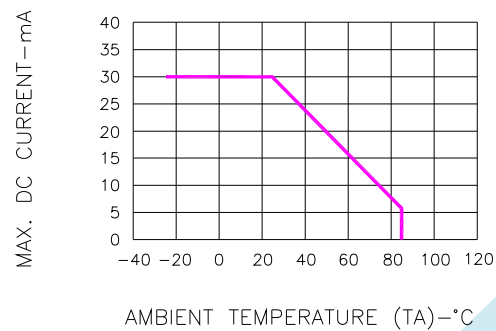


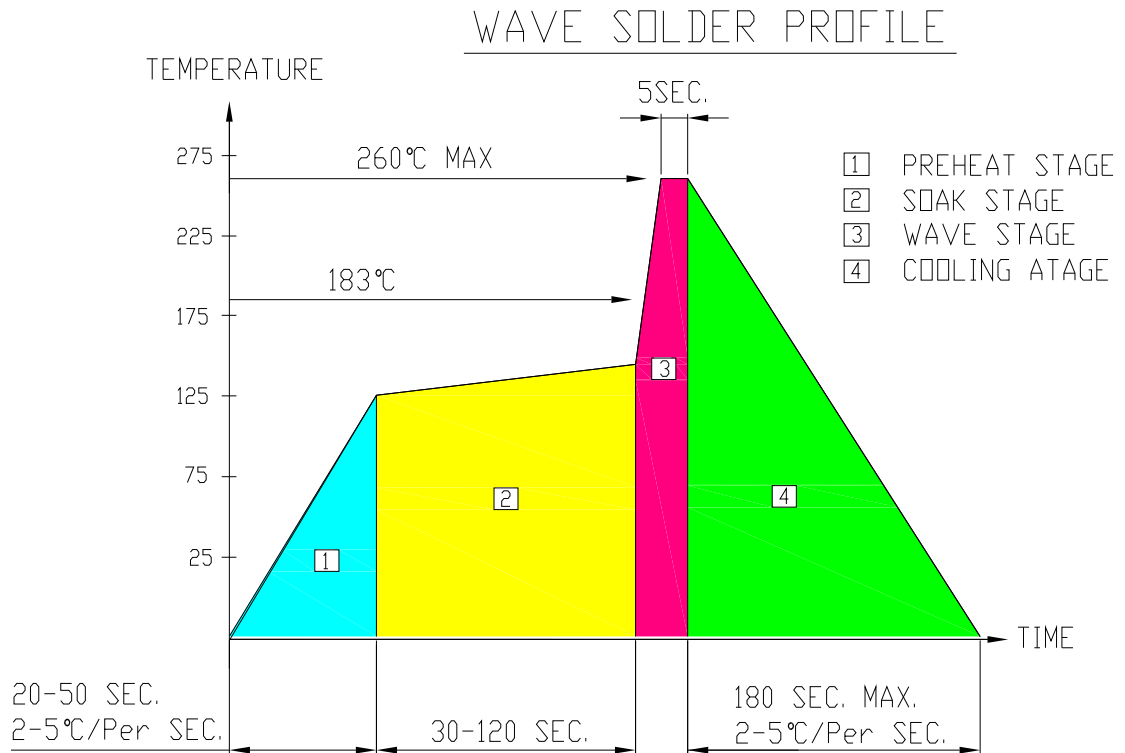
Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE



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SOLDERING CONDITIONS – DISPLAY TYPE LED

● RECOMMEND SOLDERING PROFILE



● SOLDERING IRON

Basic spec is ≤ 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● REWORK

Customer must finish rework within ≤ 4 sec under 245°C.



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